Preliminary Specification

PRODUCT NAME: RTS18160128FHC04
PRODUCT NO.: 9916885000

CUSTOMER
APPROVED BY
DATE:

RITDISPLAY CORP. APPROVED

REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	■ INITIAL RELEASE	2010. 01. 14	

CONTENTS

1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Assembly Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications.

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored or used as the conditions specified in the specifications. Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.
After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

3.1 OLED MODULE

- Small molecular organic light emitting diode.
- Color : 262 K color and 65K colors
- Panel resolution : 160*128
- Driver IC : SSD1353
- Excellent Quick response time : 10μs
- Extremely thin thickness for best mechanism design. : 1.61 mm
- High contrast : 2000:1
- Wide viewing angle : 160°
- Strong environmental resistance.
- 8/9/16/18-bits 6800/8080-series Parallel Interface, Serial Peripheral Interface.
- Wide range of operating temperature : -40 to 70°C
- Anti-glare polarizer.

3.2 TOUCH PAD (T/P) IC:

- Driver IC: STMPE16M31.
- 12 Capacitive Sensor Inputs.
- Operating voltage 2.7-5.5V.
- I^2C interface (Up to 400KHz).
- I^2C Address: 0x58,0x59,0x5A,0x5B.

4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	160 x 3 x 128	dot
2	Dot Size	0.048 (W) x 0.199 (H)	mm^2
3	Dot Pitch	0.073 (W) x 0.219 (H)	mm^2
4	Aperture Rate	60	%
5	Active Area	35.015 (W) x 28.012 (H)	mm^2
6	Panel Size	42.8 (W) x 33.5 (H)	mm^2
7*	Panel Thickness	1.42 ± 0.1	mm
8	Module Size	42.8 (W) x 60.05 (H) x 1.61 (T)	mm^3
9	Diagonal A/A size	1.8	inch
10	Module Weight	5.19 ± 10%	gram

* Panel thickness includes substrate glass, cover glass and UV glue thickness.

5. MAXIMUM RATINGS

5.1 OLED IC

ITEM	MIN	MAX	UNIT	Condition	Remark
Supply Voltage (V_{CI})	-0.5	3.5	V	Ta = 25°C	IC maximum rating
Supply Voltage (Vcc)	10	21	V	Ta = 25°C	IC maximum rating
Operating Temp.	-40	70	°C		
Storage Temp	-40	85	°C		
Humidity		85	%		
Life Time	12,000	-	Hrs	70 cd/m^2, 50% checkerboard	Note (1)
Life Time	16,000	-	Hrs	50 cd/m^2, 50% checkerboard	Note (2)

Note:

(A) Under Vcc = 17V, Ta = 25°C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 70 cd/m^2 :

- Master contrast setting : 0x0f
- Frame rate : 85Hz
- Duty setting : 1/128

(2) Setting of 50 cd/m^2 :

- Master contrast setting : 0x0b
- Frame rate : 85Hz
- Duty setting : 1/128

5.2 TP IC

Absolute Maximum Rating

Symbol	Description	Maximum	Unit
Vcc	Supply Voltage	2.5	V
Vio	GPIO Supply Voltage	6	V
VESD(HBM)	ESD protection on each GPIO/TOUCH pin	8	KV

Recommended Operating Condition

Symbol	Description	Minimun Value	Maximun Value	Unit
Vcc	Supply Voltage	1.65	1.95	V
Vio	GPIO Supply Voltage	2.7	5.5	V
GPIO	GPIO Input Voltage	GND-0.5	VIO+0.5	KV

6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

i. OLED IC

SYMBOL	PARAMETERS	TEST CONDITION	MIN	TYP	MAX	UNIT
V_{CC}	Driver power supply (for OLED panel)		16.5	17	17.5	V
V_{CI}	Low voltage power supply (for driver IC)		2.4	2.8	3.5	V
V_{DDIO}	Logic I/O operating voltage		1.6	1.8	V_{CI}	V
V_{OH}	High logic output level	Iout=100uA	0.9*V_{DDIO}		V_{DDIO}	V
V_{OL}	Low logic output level	Iout=100uA	0		0.1*V_{DDIO}	V
V_{IH}	High logic input level	Iout=100uA	0.8*V_{DDIO}		V_{DDIO}	V
V_{IL}	Low logic input level	Iout=100uA	0		0.2*V_{DDIO}	V
I_{CC}	Operating current for V_{CC} (No panel attached)	Contrast=FF		8.9	10	mA
I_{CI}	Operating current for V_{CI} (No panel attached)	Contrast=FF		890	980	uA
I_{SEG}	Segment output current (No panel attached)	Contrast=FF		160	175	uA
		Contrast=7F		80		uA

ii. TP IC

-40 to 85C unless stated otherwise

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Vcc	Core supply voltage		1.65	-	1.95	V
Vio	IO supply voltage		2.7	-	5.5	V
VIL	Input Voltage Low State(RESET/A0/A1 /I2C)	Vcc=1.8V	-0.3V		0.35Vcc	V
VIH	Input Voltage High State(RESET/A0/A1 /I2C)	Vcc=1.8V	0.75Vcc		Vcc+0.3V	V
VIL	Input Voltage Low State(GPIO)	Vio=2.7-5.5V	-0.3V		0.35Vio	V

VIH	Input Voltage High State(GPIO)	Vio=2.7-5.5V	0.65Vio		Vio+0.3V	V
VOL	Output Voltage Low State(GPIO)	Vio=2.7-5.5V, IOL=12mA	-0.3V		0.25Vio	V
VOH	Output Voltage High State(GPIO)	Vio=2.7-5.5V, IOL=12mA	0.75Vio		Vio+0.3V	V
Ileakage	Input leakage on all GPIO/Touch pins	Vio=5.5V, Vcc powered by Vio, I/O set as input, 5.5V applied to I/O			100	nA

6.2 ELECTRO-OPTICAL CHARACTERISTICS

i. OLED PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS
Normal mode current	-	39	41	mA	All pixels on (1)
Standby mode current	-	3	5	mA	Standby mode 10% pixels on (2)
Normal mode power consumption	-	663	697	mW	All pixels on (1)
Standby mode power consumption	-	51	85	mW	Standby mode 10% pixels on (2)
Pixel Luminance	50	70		cd/m^2	Display Average
Standby Luminance		20		cd/m^2	
CIEx (White)	0.27	0.31	0.35		CIE1931
CIEy (White)	0.29	0.33	0.37		CIE1931
CIEx (Red)	0.62	0.66	0.70		CIE1931
CIEy (Red)	0.29	0.33	0.37		CIE1931
CIEx (Green)	0.26	0.30	0.34		CIE1931
CIEy (Green)	0.59	0.63	0.67		CIE1931
CIEx (Blue)	0.10	0.14	0.18		CIE1931
CIEy (Blue)	0.14	0.18	0.22		CIE1931
Dark Room Contrast	2000:1				
Viewing Angle	160			degree	
Response Time		10		μs	

Normal mode condition :

- Driving Voltage : 17V
- Contrast setting : 0x0f
- Frame rate : 85Hz
- Duty setting : 1/128

Standby mode condition :

- Driving Voltage : 17V
- Contrast setting : 0x05
- Frame rate : 85Hz
- Duty setting : 1/128

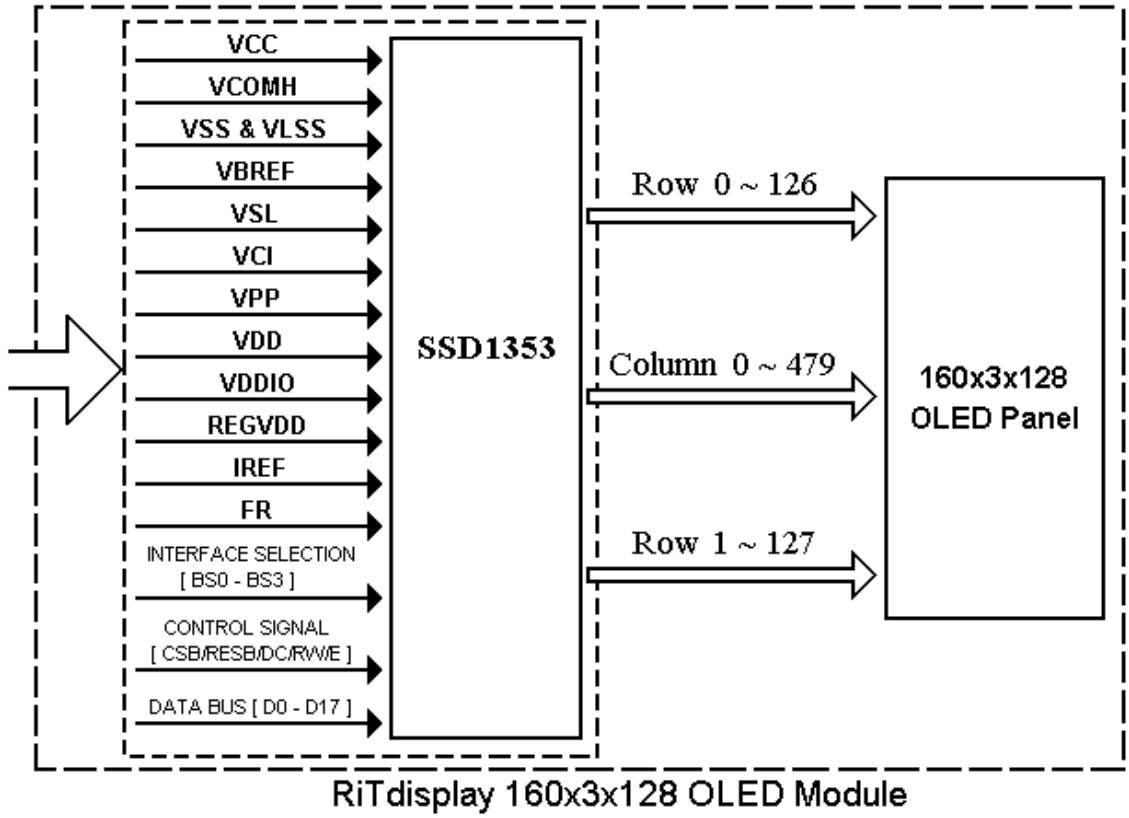
ii. TP PANEL ELECTRICAL SPECIFICATIONS

-40 to 85C unless stated otherwise

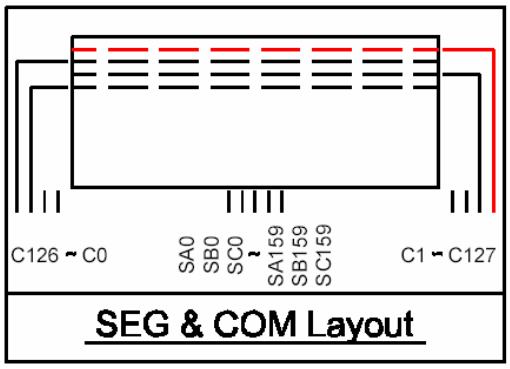
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Iactive	ACTIVE current	2MHz/32 sensor clock, slider engine active		650	950	uA
Iactive	ACTIVE current	2MHz/32 sensor clock, with/without touch, key only		450	650	uA
Isleep	SLEEP current	2MHz/32 sensor clock, with/without touch, key only		80	120	uA
Ihibernate	HIBERNATE current	No sensing capability. Hotkey available		5	8	uA

7. INTERFACE

7.1 FUNCTION BLOCK DIAGRAM (OLED)



7.2 PANEL LAYOUT DIAGRAM (OLED)



7.3 PIN ASSIGNMENTS

i. OLED MODULE

PIN NO	PIN NAME	DESCRIPTION
1	VCC	Power supply for panel driving voltage.
2	VCOMH	A capacitor should be connected between this pin and VSS.
3	VLSS	Analog system ground pin.
4	VSS	Ground pin.
5	VBREF	Connect to ground with a capacitor.
6	VSL	This is segment voltage reference pin.
7	VCI	Low voltage power supply.
8	VPP	Connect to VDD.
9	VDD	Power supply input for logic.
10	VDDIO	Power supply for interface logic level.It should be match with the MCU interface voltage level. VDDIO must always be equal or lower than VCI.
11.	REGVDD	Internal VDD regulator selection pin. When this pin is pulled high,internal VDD regulator is enabled. When this pin is pulled low,external VDD regulator is used.
12	BS0	Interface selection pins.
13	BS1	
14	BS2	
15	BS3	
16	FR	It should be kept NC.
17	CSB	This pad is the chip select input. Low active.
18	RESB	This is a reset signal input. Low active.
19	DC	D/C=”H”: Data. D/C=”L”: Command.
20	RW	When connected to 8080-series MPU. WR pin. When RW =”L”: Write signal input. When connected to 6800-series MPU. When RW =”H”: Read. When RW =”L”: Write.
21	E	When connected to 8080-series MPU. RD pin. When E =”L”: Read signal input. When connected to 6800-series MPU. Enable clock input of the 6800 series MPU.
22	D0	18 bit / 16bit / 9bit / 8 bit Data bus I/O.
23	D1	
24	D2	
25	D3	
26	D4	
27	D5	
28	D6	

29	D7	
30	D8	
31	D9	
32	D10	
33	D11	
34	D12	
35	D13	
36	D14	
37	D15	
38	D16	
39	D17	
40	IREF	A resistor should be connected between this pin and VSS.
41	VSS	Ground pin.
42	VLSS	Analog system ground pin.
43	VCOMH	A capacitor should be connected between this pin and VSS.
44	VCC	Power supply for panel driving voltage.
45	NC	No connection.

ii. TP MODULE

PIN NO.	PIN NAME	DESCRIPTION
1	ADDRESS0	I^2C Address 0.
2	ADDRESS1	I^2C Address 1.
3	RST	Reset pin (Active Low).
4	TINT	Touch Interrupt pin.
5	VCC_TP	Power supply pin for STMPE16M31.
6	GND_TP	Ground pin for STMPE16M31.
7	SDA	I^2C Data pin.
8	SCL	I^2C Clock pin.

7.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP (OLED)

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 160x132x18bits.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software.

For vertical scrolling of the display, an internal register storing display start line can be set to control the portion of the RAM data to be mapped to the display.

Each pixel has 18-bit data. Each sub-pixels for color A, B and C have 6 bits. The arrangement of data pixel in graphic display data RAM is shown below.

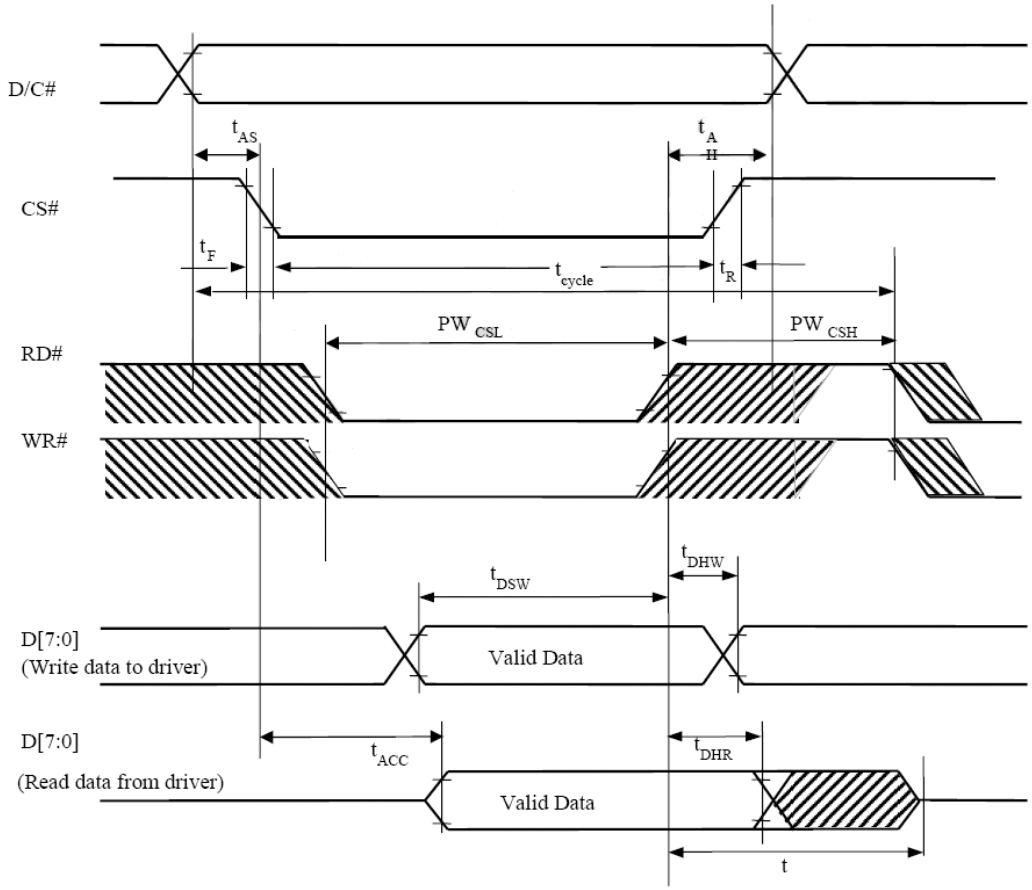
Data Format / Common Address		A5	B5	C5	A5	B5	C5	A5	.....	.....	C5	A5	B5	C5	
		A4	B4	C4	A4	B4	C4	A4	.....	.....	C4	A4	B4	C4	
		A3	B3	C3	A3	B3	C3	A3	.....	.....	C3	A3	B3	C3	
		A2	B2	C2	A2	B2	C2	A2	.....	.....	C2	A2	B2	C2	
		A1	B1	C1	A1	B1	C1	A1	.....	.....	C1	A1	B1	C1	
		A0	B0	C0	A0	B0	C0	A0	.....	.....	C0	A0	B0	C0	Common output
Normal	Remapped														
0	131	6	6	6	6	6	6	6	.....	.....	6	6	6	6	COM0
1	130	6	6	6					.....	.....					COM1
2	129								.....	.....					COM2
3	128								.....	.....					COM3
4	127								.....	.....					COM4
5	126								.....	.....					COM5
6	125			no of bits in this cell					.....	.....					COM6
7	124								.....	.....					COM7
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:	
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:	
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:	
127	4								.....	.....					
128	3								.....	.....					COM128
129	2								.....	.....					COM129
130	1								.....	.....					COM130
131	0								.....	.....					COM131

SEG output	SA0	SB0	SC0	SA1	SB1	SC1	SA2	.....	.....	SC158	SA159	SB159	SA159

7.5 INTERFACE TIMING CHART (OLED)

(V_{DD} - V_{SS} = 2.4 to 2.6V, V_{DDIO}=1.6V, T_A = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	0	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	7	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (read) Chip Select Low Pulse Width (write)	120 60	-	-	ns
PW_{CSH}	Chip Select High Pulse Width (read) Chip Select High Pulse Width (write)	60 60	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns



8080-series MPU parallel interface characteristics

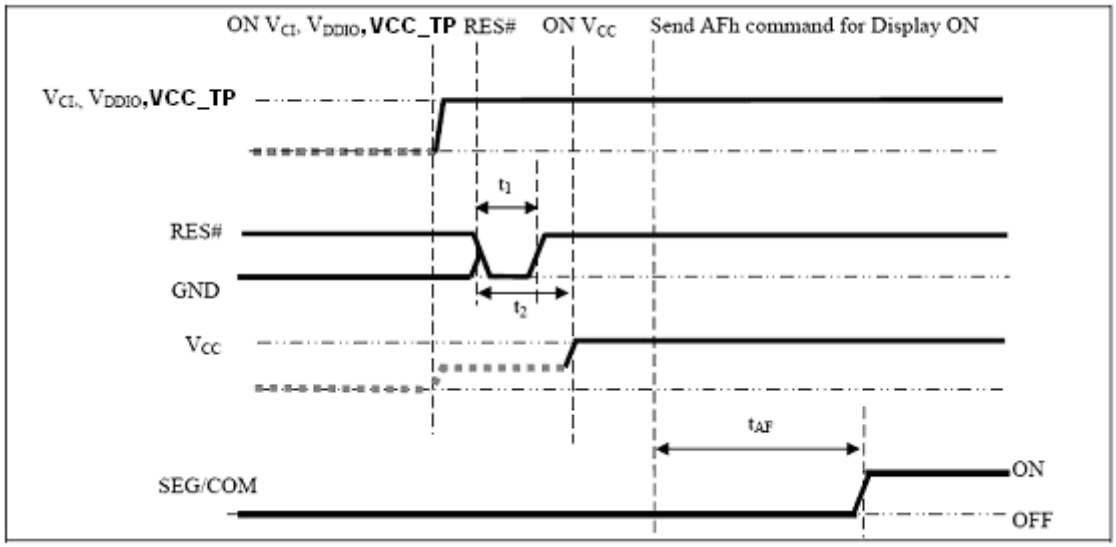
8. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

8.1 Power ON/OFF Sequence (OLED and T/P)

Power ON sequence:

1. Power ON V_{CI}, V_{DDIO},VCC_TP
2. After V_{CI}, V_{DDIO} become stable, set RES# pin LOW (logic low) for at least 100us (t_1) and then HIGH(logic high).
3. After set RES# pin LOW (logic low), wait for at least 100us (t_2). Then Power ON V_{CC}.(1)
4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 200ms(t_{AF}).

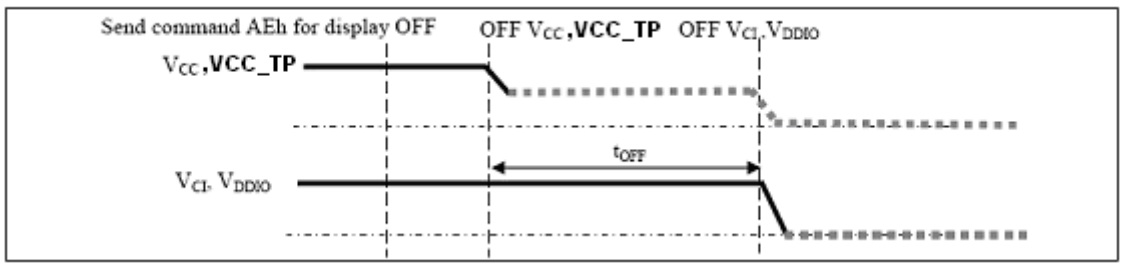
The Power ON sequence.



Power OFF sequence:

1. Send command AEh for display OFF.
2. Power OFF V_{CC},VCC_TP.(1), (2)
3. Wait for t_{OFF}. Power OFF V_{CI},, V_{DDIO}.
   (Where Minimum t_{OFF}=80ms, Typical t_{OFF}=100ms)

The Power OFF sequence



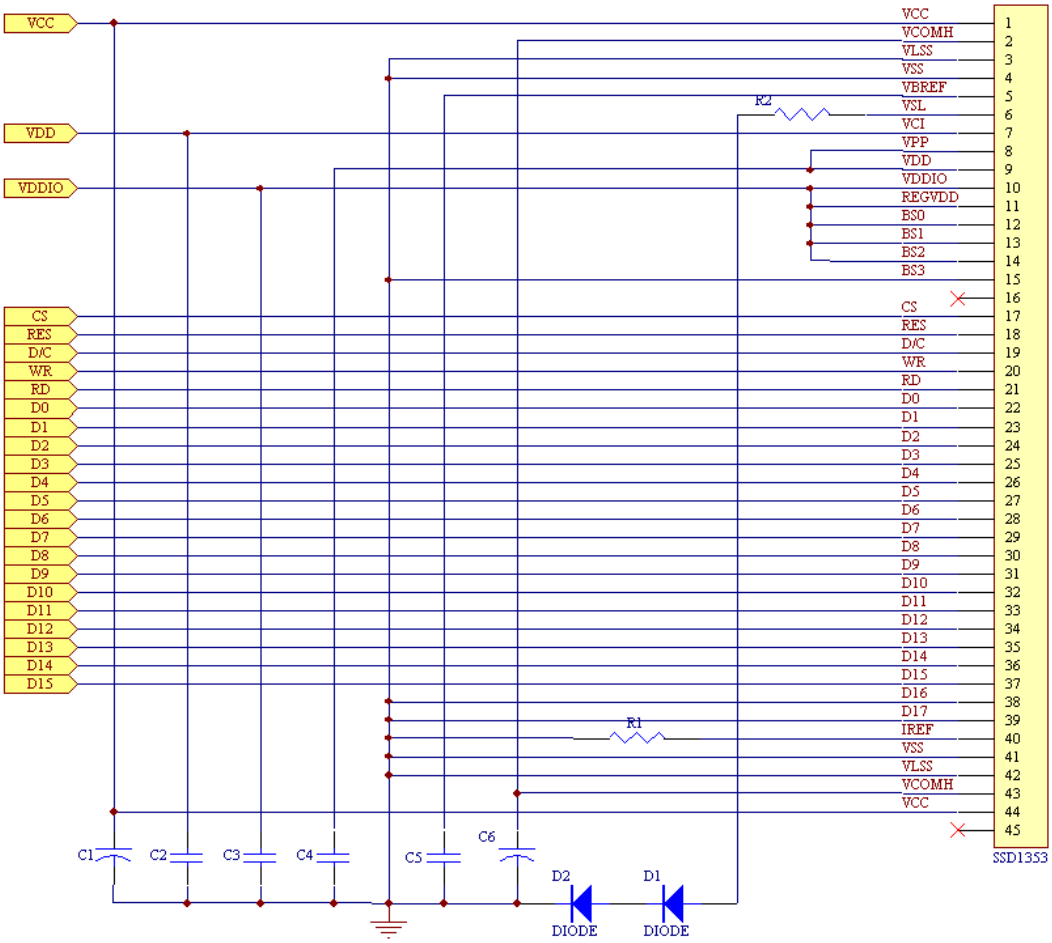
Note:

(1) Since an ESD protection circuit is connected between V_{CI}, V_{DDIO} and V_{CC}, V_{CC} becomes lower than V_{CI} whenever V_{CI},V_{DDIO} is ON and V_{CC} is OFF as shown in the dotted line of V_{CC} in above figures.

(2) V_{CC} should be disabled when it is OFF.

8.2 APPLICATION CIRCUIT

i. OLED MODULE



Component:

C1, C6 : 4.7 uF/25 ~ 35V **Tantalum type capacitor.**

C2, C3, C4 : 1uF/ 16V

C5 : 0.1uF/ 16V

R1: 1.2M ohm 1%

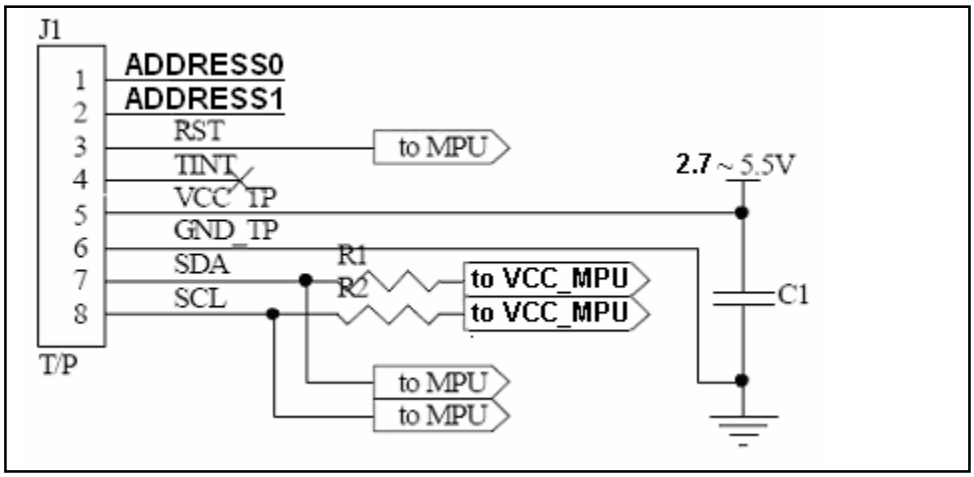
R2: 50ohm 1/4W

D1 and D2: RB480K (ROHM)

This circuit is for 8080 16bits interface.

ii. TP MODULE

1. No use Interrupt

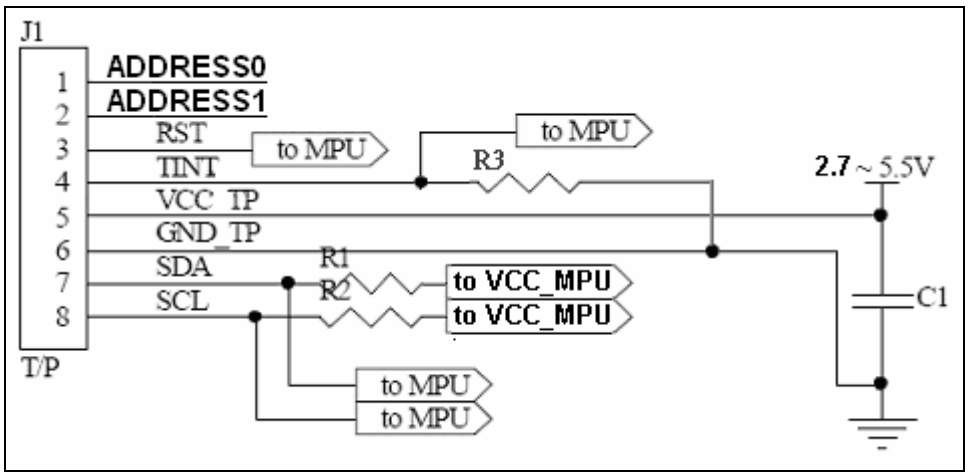


Recommended components

C1 : 1uF/ 16V (0603)

R1,R2 : 10K ohm, 1% (0603)

2. Use Interrupt active high (pull-down)

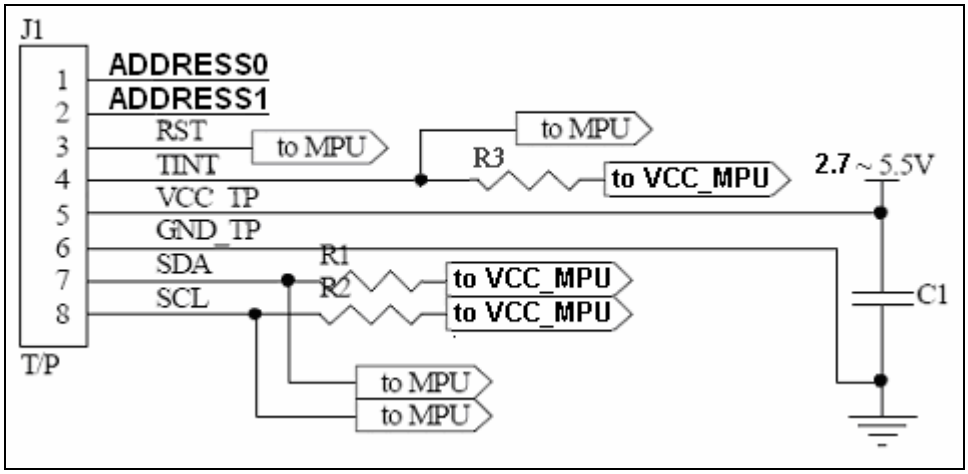


Recommended components

C1 : 1uF/ 16V (0603)

R1,R2,R3 : 10K ohm, 1% (0603)

3. Use Interrupt active low (pull-up)



Recommended components

C1 : 1uF/ 16V (0603)

R1,R2,R3 : 10K ohm, 1% (0603)

NOTE : I2C address settings.

Address 1	Address 0	I2C Address
0	0	0x58
0	1	0x59
1	0	0x5A
1	1	0x5B

8.3 COMMAND TABLE

Refer to IC Spec : SSD1353 / STMPE16M31.

9. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85°C, 240hrs	5
2	High temp. (Operation)	70°C, 120hrs	5
3	Low temp. (Operation)	-40°C, 120hrs	5
4	High temp. / High humidity (Operation)	65°C, 90%RH, 96hrs	5
5	Thermal shock (Non-operation)	-40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 20 cycles	5
6	Vibration	Frequency : 5~50HZ, 0.5G Scan rate : 1 oct/min Time : 2 hrs/axis Test axis : X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence : 1 angle、3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±6kV, 10 times	5

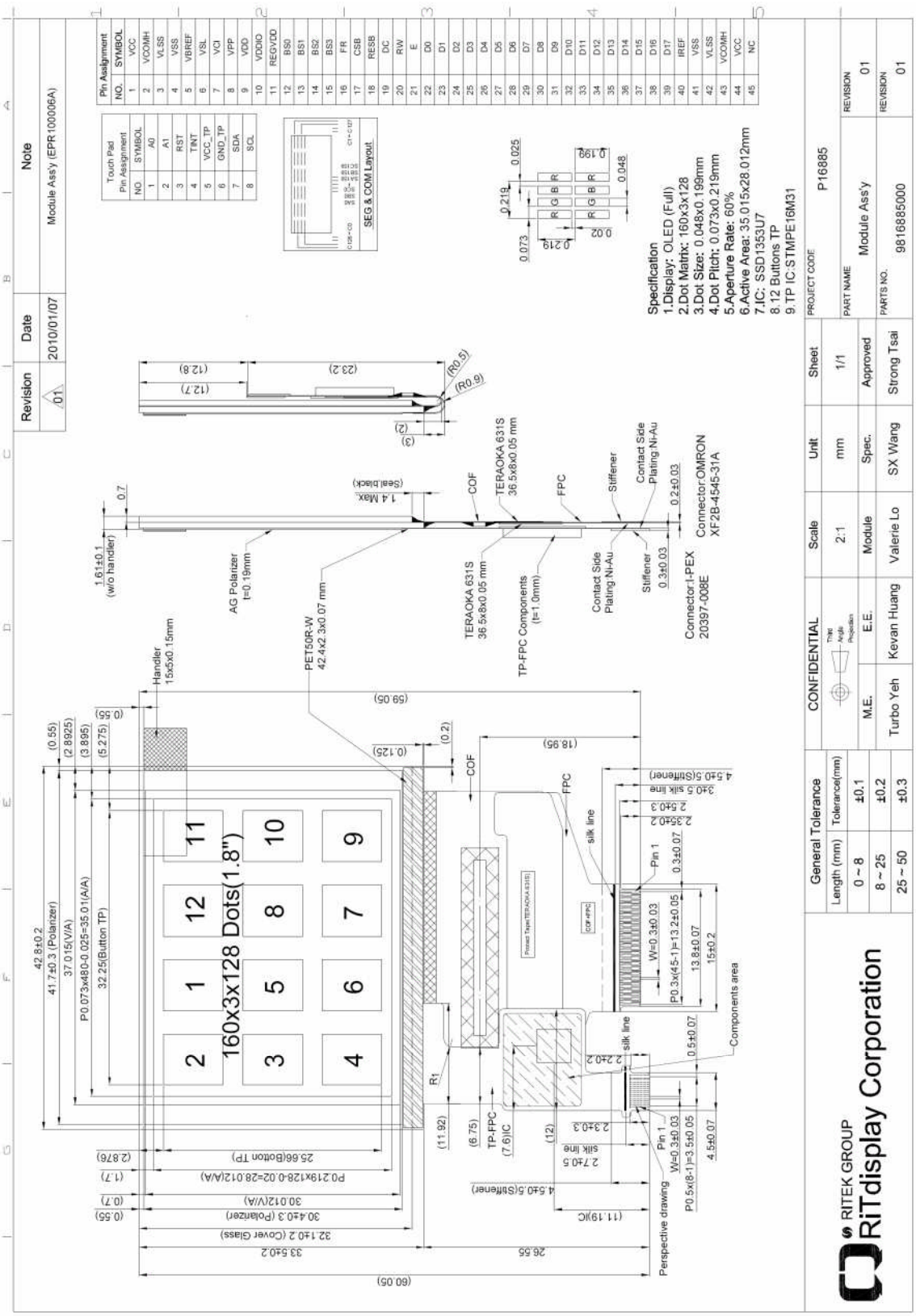
Test and measurement conditions

1. All measurements shall not be started until the specimens attain to temperature stability.
2. All-pixels-on is used as operation test pattern.
3. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

1. The function test is OK.
2. No observable defects.
3. Luminance: > 50% of initial value.
4. Current consumption: within ± 50% of initial value.

10. EXTERNAL DIMENSION



11. PACKING SPECIFICATION

TBD

12. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

$$\text{Contrast Ratio} = \frac{\text{Luminance of all pixels on measurement}}{\text{Luminance of all pixels off measurement}}$$

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

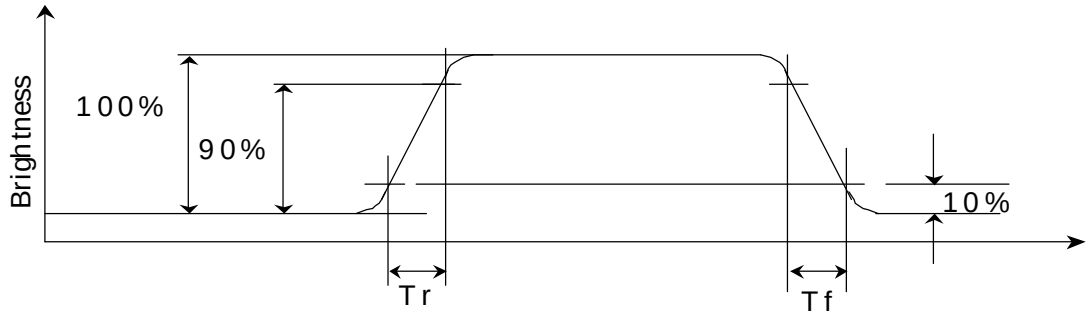
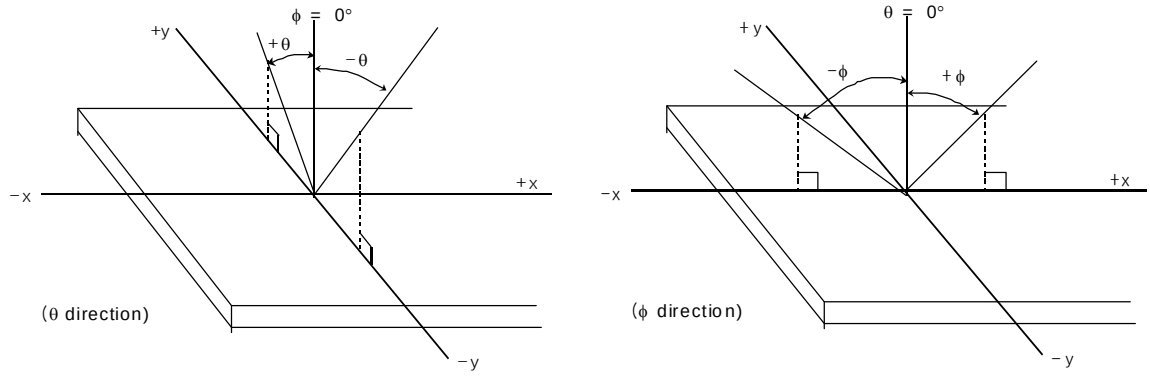


Figure 2 Response time

D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.



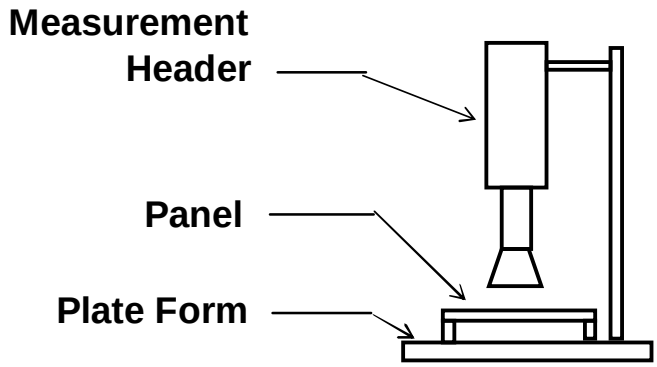
Vertical angles **Horizontal angles**

Figure 3 Viewing angle

APPENDIX 2: MEASUREMENT APPARATUS

A. LUMINANCE/COLOR COORDINATE

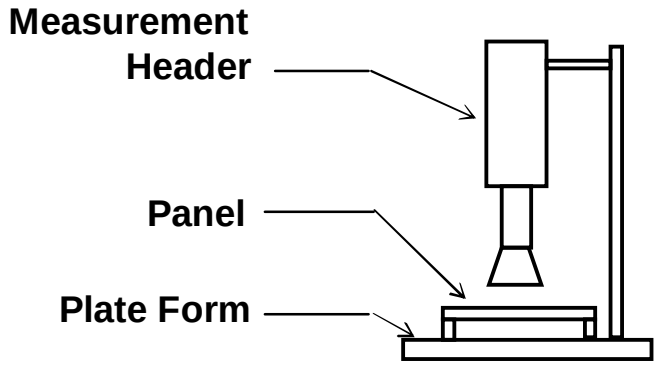
PHOTO RESEARCH PR-705, MINOLTA CS-100



**PR-705 /
MINOLTA CS-100
Color Analyzer**

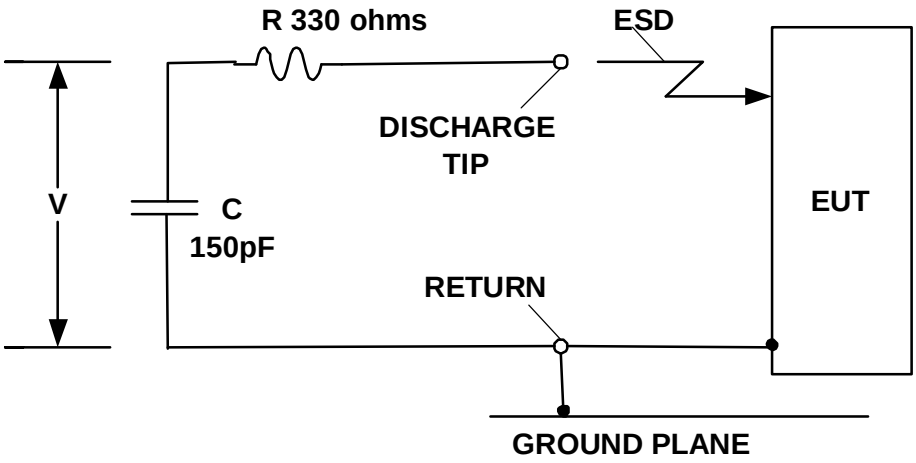
B. CONTRAST / RESPONSE TIME / VIEWING ANGLE

WESTAR CORPORATION FPM-510



**Westar FPM-510
Display Contrast /
Response time /
View angle Analyzer**

C. ESD ON AIR DISCHARGE MODE



APPENDIX 3: PRECAUTIONS

A. RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.